

LQ-M85200-SR4C

200GBASE-SR4 QSFP56, Optical Transceiver Module, 100mReach

Features

- Hot-pluggable QSFP56 form factor
- Built-in 200G PAM4 DSP
- Supports 212.5Gb/s aggregate bit rates
- Supports 103.125Gb/s aggregate bit rates if required
- Low power dissipation <5W
- RoHS-6 compliant (lead-free)
- Commercial case temperature range of 0°C to 70°C
- Single 3.3V power supply
- Maximum link length of 70m on OM3 MMF and 100m on OM4 & OM5 MMF
- Uncooled 4 channels 850nm VCSEL array
- 4 channels PIN photo detector array
- 200GAUI-4 electrical interface
- Single MPO12 receptacle
- CMIS V4.0 compliant
- Built-in digital diagnostic functionality



Applications

- IEEE 802.3cd 200GBASE-SR4 Ethernet(PAM4)

Description

LINK-PP LQ-M85200-SR4C 200GE QSFP56 Optical Transceiver modules are designed for use in 200 Gigabit Ethernet links over OM3/OM4/OM5 multi-mode fiber. They are compliant with the QSFP MSA and with IEEE 802.3cd 200GBASE-SR4 specification. Digital diagnostics functions are available via the I2C interface as specified by CMIS V4.0. The transceiver is RoHS 2.0 compliant and lead-free per Directive 2011/65/EU.

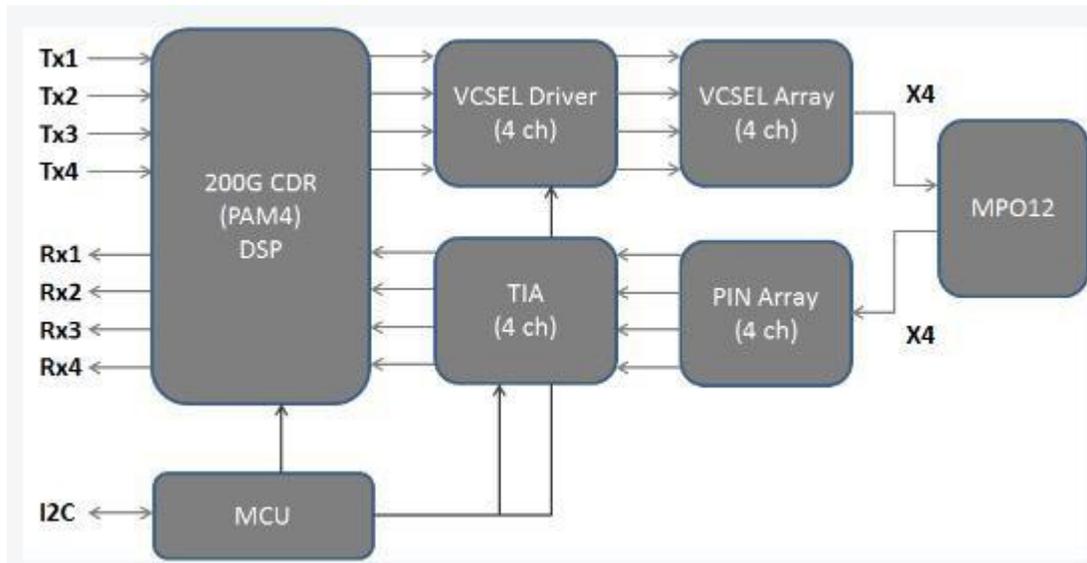


Figure 1. Module Block Diagram

Absolute Maximum Ratings

| Parameter | Symbol | Min | Max | Unit |
|----------------------------|----------|------|--------------|------|
| Supply Voltage | V_{cc} | -0.3 | 3.6 | V |
| Input Voltage | V_{in} | -0.3 | $V_{cc}+0.3$ | V |
| Storage Temperature | T_s | -40 | 85 | °C |
| Case Operating Temperature | T_c | 0 | 70 | °C |
| Humidity (non-condensing) | Rh | 5 | 95 | % |

Recommended Operating Conditions

| Parameter | Symbol | Min | Typical | Max | Unit |
|----------------------------|----------|------|---------|------|---------|
| Supply Voltage | V_{cc} | 3.13 | 3.3 | 3.47 | V |
| Operating Case Temperature | T_c | 0 | | 70 | °C |
| Baud Rate per Lane (PAM4) | fd | | 26.5625 | | GBaud/s |
| Humidity | Rh | 5 | | 85 | % |
| Power Dissipation | P_m | | 4.1 | 4.5 | W |
| Fiber Bend Radius | R_b | 3 | | | cm |

Electrical Specifications

| Parameter | Symbol | Min | Typical | Max | Unit |
|---------------------------------------|------------------|--------------|---------|----------|------|
| Differential Input Impedance | Z_{in} | 90 | 100 | 110 | ohm |
| Differential Output Impedance | Z_{out} | 90 | 100 | 110 | ohm |
| Differential Input Voltage Amplitude | ΔV_{in} | 300 | | 1000 | mVpp |
| Differential Output Voltage Amplitude | ΔV_{out} | 300 | | 900 | mVpp |
| Bit Error Rate ^{Note2} | BER | | | 2.4E-4 | |
| Input Logic Level High | V_{IH} | 2.0 | | V_{CC} | V |
| Input Logic Level Low | V_{IL} | 0 | | 0.8 | V |
| Output Logic Level High | V_{OH} | $V_{CC}-0.5$ | | V_{CC} | V |
| Output Logic Level Low | V_{OL} | 0 | | 0.4 | V |

Note:

Note2. Compliant with 200GBASE-SR4 electrical specification in IEEE802.3cd standard.

Optical Characteristics

| Parameter | Symbol | Min | Typical | Max | Unit |
|---|-----------------|------|---------|------|------|
| Transmitter | | | | | |
| Center Wavelength | λ_c | 840 | 850 | 860 | nm |
| RMS Spectral Width | $\Delta\lambda$ | | | 0.6 | nm |
| Average Launch Power (each lane) | P_{out} | -6.5 | | 4 | dBm |
| Outer Optical Modulation Amplitude (each lane) | OMA_{out} | -4.5 | | 3 | dBm |
| Launch power in OMA_{outer} minus TDECQ | P_{tdecq} | -5.9 | | | dBm |
| Transmitter and dispersion eye closure (each) | TDEC | | | 4.5 | dB |
| Average launch power of off transmitter(each) | P_{off} | | | -30 | dBm |
| Outer Extinction Ratio | ER | 3 | | | dB |
| Optical Return Loss Tolerance | ORLT | | | 12 | dB |
| Receiver | | | | | |
| Center Wavelength | λ_c | 840 | 850 | 860 | nm |
| Damage threshold | R_{dam} | | | 4 | dBm |
| Average Receive Power (each lane) | P_{in} | -7.9 | | 4 | dBm |
| Receiver Power (OMA_{outer}) (each lane) | OMA_{out} | | | 3 | dBm |
| Receiver reflectance | P_{ref} | | | -12 | dB |
| Stressed Receiver Sensitivity (OMA_{outer}) (each lane) | Sens | | | -3 | dBm |
| Receiver Sensitivity (OMA_{outer}) (each lane) ^{Note3} | Sen | | | -7 | dBm |
| LOS Assert | | | | -10 | dBm |
| LOS De-Assert | | | | -8.5 | dBm |
| LOS Hysteresis | | 0.5 | | | dB |

Note:

Note3. Measured with conformance test signal at TP3 for BER = 2.4E-4 Pre-FEC

Pin Description

| Pin | Logic | Symbol | Name/Description |
|-----|-------------------------|---------------------|--|
| 1 | | GND | Module Ground ^{Note5} |
| 2 | CML-I | Tx2- | Transmitter inverted data input |
| 3 | CML-I | Tx2+ | Transmitter non-inverted data input |
| 4 | | GND | Module Ground ^{Note5} |
| 5 | CML-I | Tx4- | Transmitter inverted data input |
| 6 | CML-I | Tx4+ | Transmitter non-inverted data input |
| 7 | | GND | Module Ground ^{Note5} |
| 8 | LVTTL-I | MODSEIL | Module Select ^{Note6} |
| 9 | LVTTL-I | ResetL | Module Reset ^{Note6} |
| 10 | | VCCR _x | +3.3V Receiver Power Supply |
| 11 | LVC _{MOS} -I | SCL | 2-wire Serial interface clock ^{Note6} |
| 12 | LVC _{MOS} -I/O | SDA | 2-wire Serial interface data ^{Note6} |
| 13 | | GND | Module Ground ^{Note5} |
| 14 | CML-O | RX3+ | Receiver non-inverted data output |
| 15 | CML-O | RX3- | Receiver inverted data output |
| 16 | | GND | Module Ground ^{Note5} |
| 17 | CML-O | RX1+ | Receiver non-inverted data output |
| 18 | CML-O | RX1- | Receiver inverted data output |
| 19 | | GND | Module Ground ^{Note5} |
| 20 | | GND | Module Ground ^{Note5} |
| 21 | CML-O | RX2- | Receiver inverted data output |
| 22 | CML-O | RX2+ | Receiver non-inverted data output |
| 23 | | GND | Module Ground ^{Note5} |
| 24 | CML-O | RX4- | Receiver inverted data output |
| 25 | CML-O | RX4+ | Receiver non-inverted data output |
| 26 | | GND | Module Ground ^{Note5} |
| 27 | LVTTL-O | ModPrsL | Module Present, internal pulled down to GND |
| 28 | LVTTL-O | IntL | Interrupt output, should be pulled up on host board ² |
| 29 | | VCCT _x | +3.3V Transmitter Power Supply |
| 30 | | VCC1 | +3.3V Power Supply |
| 31 | LVTTL-I | LPM _{Mode} | Low Power Mode ^{Note6} |
| 32 | | GND | Module Ground ^{Note5} |
| 33 | CML-I | Tx3+ | Transmitter non-inverted data input |
| 34 | CML-I | Tx3- | Transmitter inverted data input |
| 35 | | GND | Module Ground ^{Note5} |
| 36 | CML-I | Tx1+ | Transmitter non-inverted data input |

| | | | |
|----|-------|------|---------------------------------|
| 37 | CML-I | Tx1- | Transmitter inverted data input |
| 38 | | GND | Module Ground ^{Note5} |

Note:

Note5. Module circuit ground is isolated from module chassis ground within the module.

Note6. Open collector should be pulled up with 4.7K to 10K ohms on host board to a voltage between 3.15V and 3.6V.

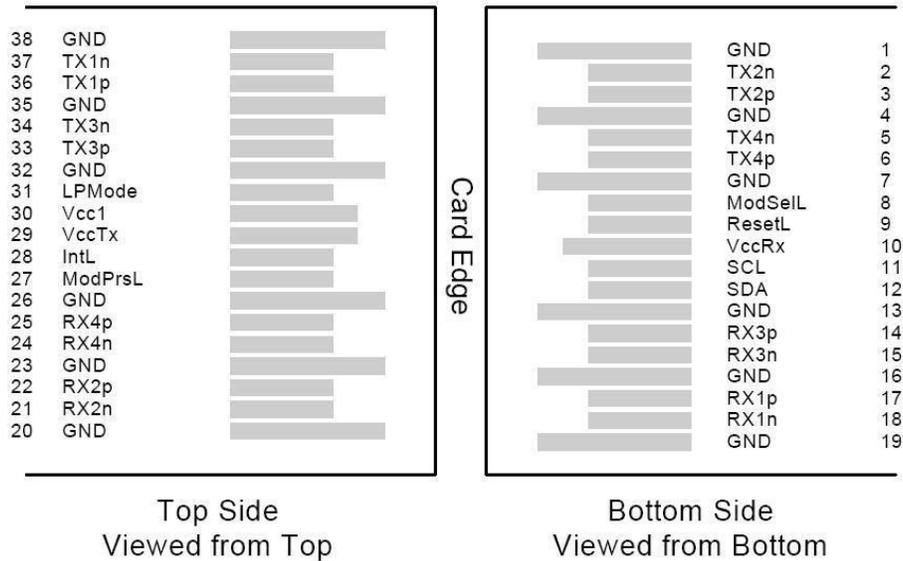


Figure 2. Electrical Pin-out Details

ModSelL Pin

The ModSelL is an input pin. When held low by the host, the module responds to 2-wire serial communication commands. The ModSelL allows the use of multiple QSFP modules on a single 2-wire interface bus. When the ModSelL is "High", the module will not respond to any 2-wire interface communication from the host. ModSelL has an internal pull-up in the module.

ResetL Pin

Reset. LPMode_Reset has an internal pull-up in the module. A low level on the ResetL pin for longer than the minimum pulse length (t_{Reset_init}) initiates a complete module reset, returning all user module settings to their default state. Module Reset Assert Time (t_{init}) starts on the rising edge after the low level on the ResetL pin is released. During the execution of a reset (t_{init}) the host shall disregard all status bits until the module indicates a completion of the reset interrupt. The module indicates this by posting an IntL signal with the Data_Not_Ready bit negated. Note that on power up (including hot insertion) the module will post this completion of reset interrupt without requiring a reset.

LPMode Pin

LINK-PP QSFP28 modules operate in the low power mode (less than 1.5 W power consumption). This pin active high

will decrease power consumption to less than 1W.

ModPrsL Pin

ModPrsL is pulled up to Vcc on the host board and grounded in the module. The ModPrsL is asserted "Low" when the module is inserted and deasserted "High" when the module is physically absent from the host connector.

IntL Pin

IntL is an output pin. When "Low", it indicates a possible module operational fault or a status critical to the host system. The host identifies the source of the interrupt by using the 2-wire serial interface. The IntL pin is an open collector output and must be pulled up to Vcc on the host board.

Power Supply Filtering

The host board should use the power supply filtering shown in Figure 3.

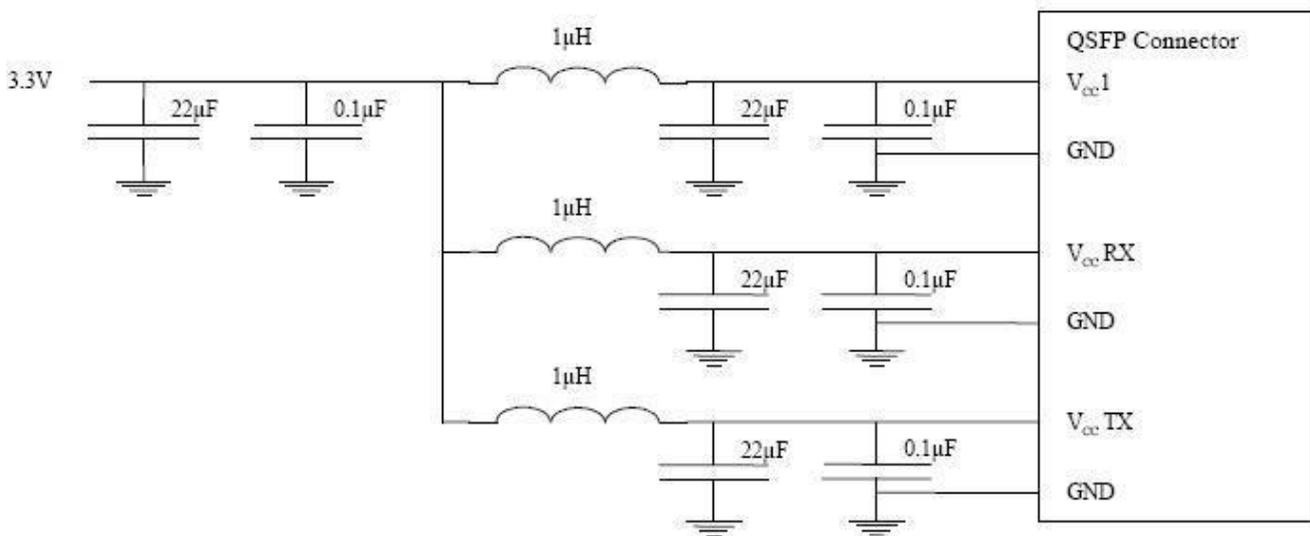
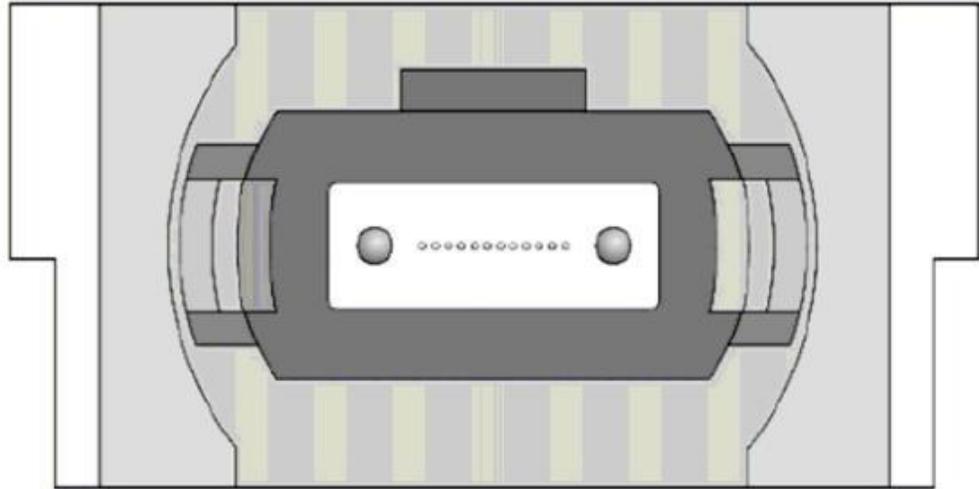


Figure 3. Host Board Power Supply Filtering

Optical Interface Lanes and Assignment

The optical interface port is a male MPO connector. The four fiber positions on the left as shown in Figure 4, with the key up, are used for the optical transmit signals (Channel 1 through 4). The fiber positions on the right are used for the optical receive signals (Channel 4 through 1). The central four fibers are physically present.



Transmit Channels: 1 2 3 4
 Unused positions: x x x x
 Receive Channels: 4 3 2 1

Figure 4. Optical Receptacle and Channel Orientation

DIAGNOSTIC MONITORING INTERFACE

Digital diagnostics functions are available via the I2C interface as specified by CMIS V4.0. The CMIS management memory is shown in Figure 5.

Due to eight-bit addresses, the management memory is divided in Lower Memory (addresses 00h through 7Fh) and Upper Memory (addresses 80h ~ FFh).

The addressing structure of the additional internal management memory is shown in Figure 6. The management memory is arranged as a unique and always host accessible address space of 128 bytes (Lower Memory) and as multiple upper address subspaces of 128 bytes each (Pages), only one of which is selected as host visible in Upper Memory. A second level of Page selection is possible for Pages for which several instances exist (e.g. where a bank of pages with the same Page number exists).

This structure supports a flat 256 byte memory for passive copper modules and permits timely access to addresses in the Lower Memory(e.g. Flags and Monitors). Less time critical entries, e.g. serial ID information and threshold settings, are available with the Page Select function in the Lower Page.

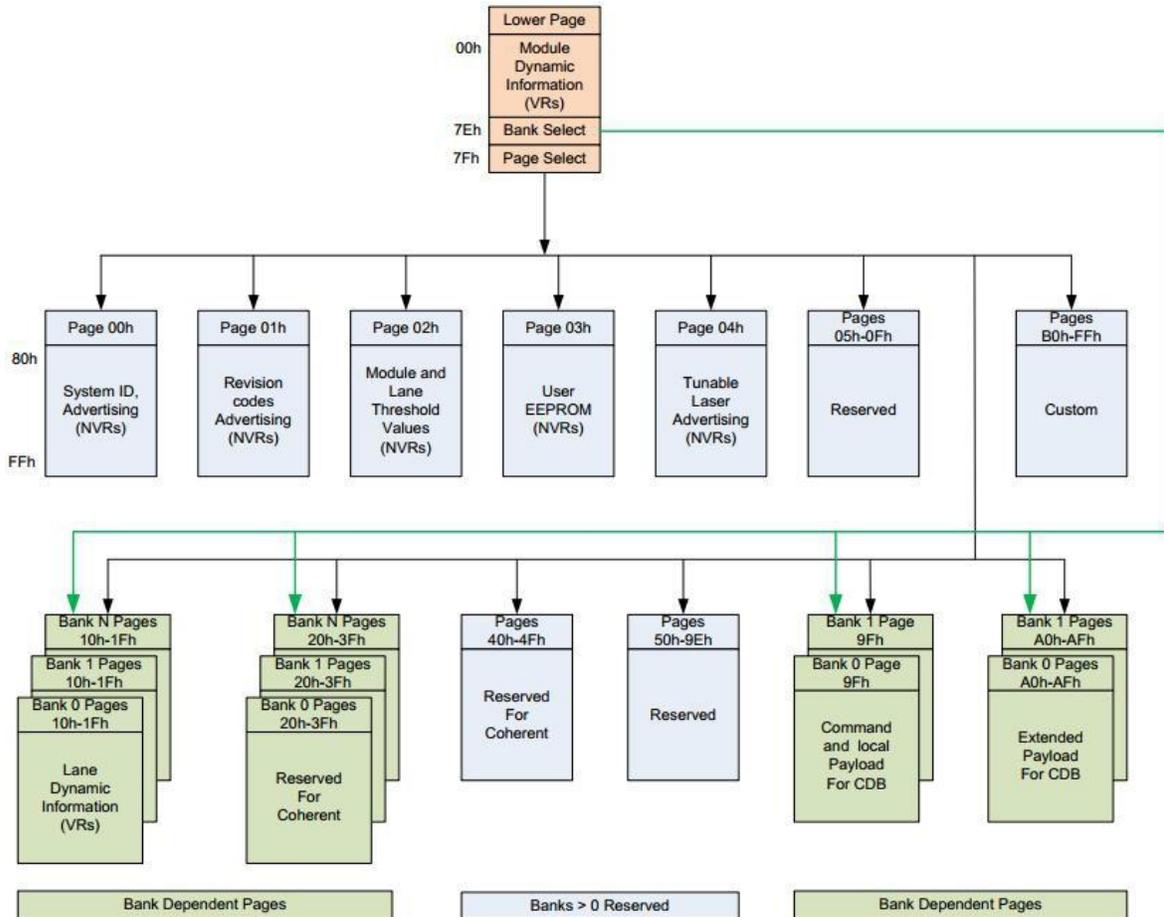


Figure 5. CMIS Bank Page Memory Map

The CMIS memory structure also provides address expansion by adding additional upper pages as needed. Upper pages 00-02 all contain static, non-volatile advertising registers. Upper page 01 provides revision codes and advertising registers that indicate the capabilities of the module. Upper page 02 provides thresholds for monitored functions. Upper page 03 provides a user read/write space.

The lower page, upper pages 00h-03h and bank 0 page 10h-11h are supported in our module.

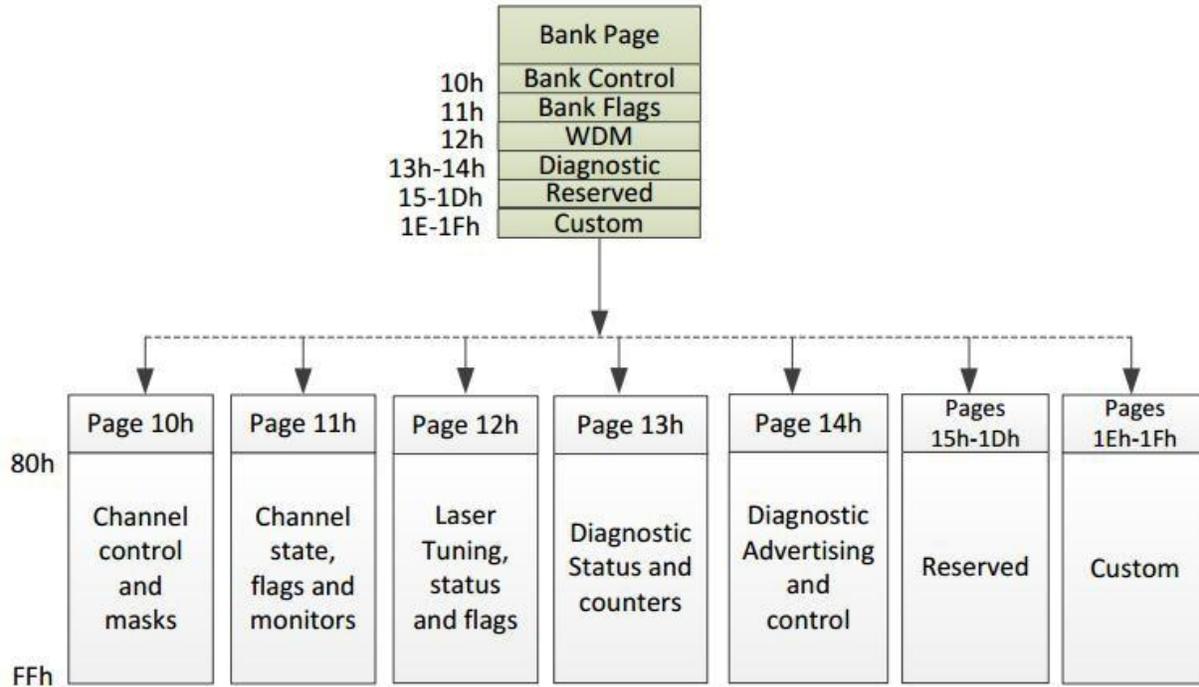


Figure 6. Additional Supported Bank Page Memory Map

The Lower Memory– Page 00h

The Lower Memory consists of the lower 128 bytes of the 256 byte two-wire serial bus addressable space. The Lower Page is used to access a variety of module level measurements, diagnostic functions and control functions, as well as to select which of the various Upper Pages in the structured memory map are accessed by byte addresses greater or equal than 128.

| Address | Size | Subject Area | Description |
|---------|------|---------------------------|---|
| 0-3 | 4 | ID and Status Area | Module ID from SFF-8024 list, version number, Type and status Flat mem indication, CLEI present indicator, Maximum TWI speed, Current state of Module, Current state of the Interrupt signal |
| 4-7 | 4 | Lane Flag Summary | Flag summary of all lane flags on pages 10h-1Fh |
| 8-13 | 6 | Module-Level Flags | All flags that are not lane or data path specific |
| 14-25 | 12 | Module-Level Monitors | Monitors that are not lane or data path specific |
| 26-30 | 5 | Module Global Controls | Controls applicable to the module as a whole |
| 31-36 | 6 | Module-Level Flag Masks | Masking bits for the Module-Level flags |
| 37-38 | 2 | CDB Status Area | Status of most recent CDB command |
| 39-40 | 2 | Module Firmware Version | Module Firmware Version. |
| 41-63 | 23 | Reserved Area | Reserved for future standardization |
| 64-82 | 19 | Custom Area | Vendor or module type specific use |
| 83-84 | 2 | Inactive Firmware Version | Version Number of Inactive Firmware. Values of 00h indicates module supports only a single image. |
| 85-117 | 33 | Application Advertising | Combinations of host and media interfaces that are supported by module data path(s) |
| 118-125 | 8 | Password Entry and Change | |
| 126 | 1 | Bank Select Byte | Bank address of currently visible Page |
| 127 | 1 | Page Select Byte | Page address of currently visible Page |

Figure 7.The Lower Memory Overview

The Upper Memory – Page 00h

Upper page 00h contains static read-only module identification information.

| Address | Size (bytes) | Name | Description |
|---------|--------------|---------------------------------|---|
| 128 | 1 | Identifier | Identifier Type of module |
| 129-144 | 16 | Vendor name | Vendor name (ASCII) |
| 145-147 | 3 | Vendor OUI | Vendor IEEE company ID |
| 148-163 | 16 | Vendor PN | Part number provided by vendor (ASCII) |
| 164-165 | 2 | Vendor rev | Revision level for part number provided by vendor (ASCII) |
| 166-181 | 16 | Vendor SN | Vendor Serial Number (ASCII) |
| 182-189 | 8 | Date Code | |
| 190-199 | 10 | CLEI code | Common Language Equipment Identification code |
| 200-201 | 2 | Module power characteristics | |
| 202 | 1 | Cable assembly length | |
| 203 | 1 | Media Connector Type | |
| 204-209 | 6 | Copper Cable Attenuation | |
| 210-211 | 2 | Cable Assembly Lane Information | |
| 212 | 1 | Media Interface Technology | |
| 213-220 | 8 | Reserved | |
| 221 | 1 | Custom | |
| 222 | 1 | Checksum | Includes bytes 128-221 |
| 223-255 | 33 | Custom Info NV | |

Figure 8.Page 00h Memory Overview

The Upper Memory – Page 01h(Advertising)

Upper page 01h contains advertising fields that define properties that are unique to active modules and cable assemblies.

| Byte | Size (bytes) | Name | Description |
|---------|--------------|--|--|
| 128-131 | 4 | Module Firmware and Hardware revisions | |
| 132-137 | 6 | Supported link length | Supported lengths of various fiber media |
| 138-139 | 2 | Nominal Wavelength | |
| 140-141 | 2 | Wavelength Tolerance | |
| 142-144 | 3 | Implemented Memory Pages and Durations advertising | |
| 145-154 | 10 | Module Characteristics advertising | |
| 155-156 | 2 | Implemented Controls advertising | |
| 157-158 | 2 | Implemented Flags advertising | |
| 159-160 | 2 | Implemented Monitors advertising | |
| 161-162 | 2 | Implemented Signal Integrity Controls advertising | |
| 163-166 | 4 | CDB support advertising | |
| 167-168 | 2 | Additional Durations advertising | |
| 169-175 | 7 | Reserved | |
| 176-190 | 15 | Module Media Lane advertising | |
| 191-222 | 32 | Custom | |
| 223-250 | 28 | Extended Module Host-Media Interface Advertising options | |
| 251-254 | 4 | Reserved | |
| 255 | 1 | Checksum | Checksum of bytes 130-254 ¹ |

Figure 9. Page 01h Memory Overview

The Upper Memory – Page 02h (Module and Lane Thresholds)

Upper Page 02h contains the module-defined thresholds for module-level and lane-specific monitors. The presence of Page 02h is advertised in bit 7 in Page 00h byte 2.

| Byte | Size (bytes) | Name | Description |
|---------|--------------|----------------------------------|----------------------|
| 128-175 | 48 | Module-level monitor thresholds | |
| 176-199 | 24 | Lane-specific monitor thresholds | |
| 200-229 | 30 | Reserved | |
| 230-254 | 25 | Custom | |
| 255 | 1 | Checksum | Covers bytes 128-254 |

Figure 10. Page 02h Memory Overview

The Upper Memory – Page 10h (Lane and Data Path Control)

The upper memory map page 10h is a banked page that contains lane dynamic control bytes. The presence of Page 10h is advertised in bit 7 in Page 00h byte 2.

| Byte | Size (bytes) | Name | Description |
|---------|--------------|--------------------------|--|
| 128 | 1 | DataPathDeinit | Data Path control bits for each lane, controls Data Path State machine |
| 129-142 | 14 | Lane-Specific Control | Fields to control lane attributes independent of the Data Path State machine or control sets |
| 143-177 | 35 | Staged Control Set 0 | Fields to configure the selected Application Code and signal integrity settings |
| 178-212 | 35 | Staged Control Set 1 | Fields to configure the selected Application Code and signal integrity settings |
| 213-231 | 19 | Lane-Specific Flag Masks | |
| 232-239 | 8 | Reserved | |
| 240-255 | 16 | Custom | |

Figure 11. Page 02h Memory Overview

The Upper Memory – Page 11h (Lane Status)

The upper memory map page 11h is a banked page that contains lane dynamic status bytes. The presence of Page 11h is conditional on the state of bit 7 in Page 00h byte 2. All fields on Page 11h are read-only.

| Byte | Size (bytes) | Name | Description |
|---------|--------------|--|--|
| 128-131 | 4 | Data Path State indicators | |
| 132-133 | 2 | Reserved | |
| 134-152 | 19 | Lane-specific flags | |
| 153 | 1 | Reserved | |
| 154-201 | 48 | Lane-specific monitors | |
| 202-205 | 4 | Configuration Error Codes | Indicates validity of select Application codes |
| 206-234 | 29 | Active Control Set | |
| 235-239 | 5 | Reserved | |
| 240-255 | 16 | Host Electrical to Module Media Lane Mapping | Indicates the mapping of Host Electrical lanes to Module Media lanes |

Figure 12. Page 11h Memory Overview

Mechanical Dimensions

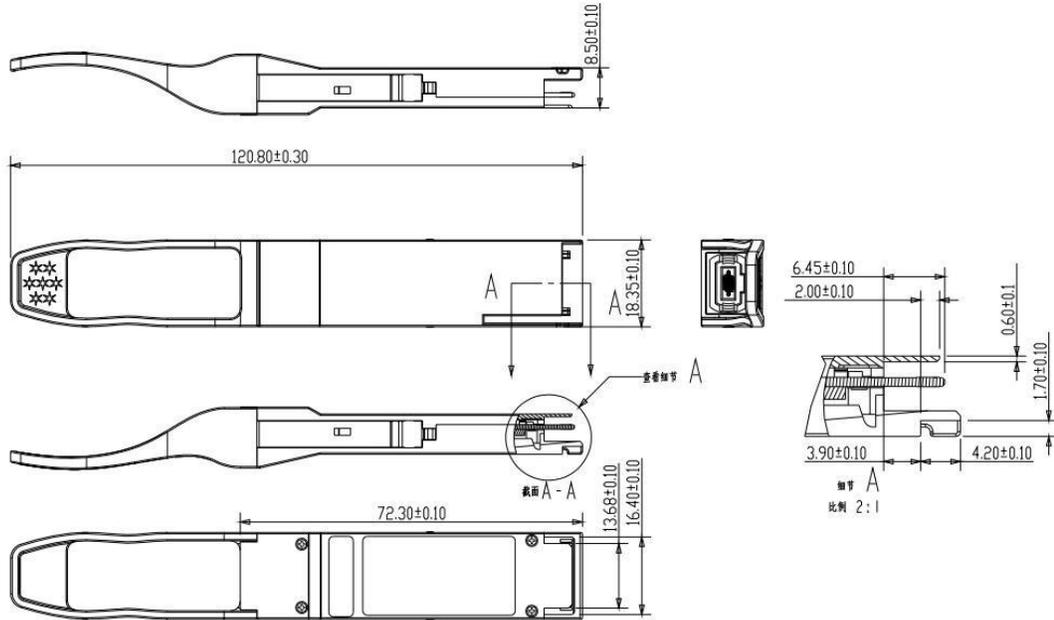


Figure 13. Mechanical Specifications

Regulatory Compliance

LINK-PP LQ-M85200-SR4C QSFP56 SR4 transceiver are Class 1 Laser Products. They are certified per the following standards:

| Feature | Standard |
|--------------------------|---|
| Laser Safety | IEC 60825-1:2014 (3 rd Edition) IEC 60825-2:2004/AMD2:2010 EN 60825-1-2014 EN 60825-2:2004+A1+A2 |
| Electrical Safety | EN 62368-1: 2014 IEC 62368-1:2014 UL 62368-1:2014 |
| Environmental protection | Directive 2011/65/EU with amendment(EU)2015/863 |
| CE EMC | EN55032: 2015 EN55035: 2017 EN61000-3-2:2014 EN61000-3-3:2013 |
| FCC | FCC Part 15, Subpart B ANSI C63.4-2014 |

References

QSFP MSA

CMISV4.0

IEEE 802.3cd200GBASE-SR4 specification

Ordering information

| Part Number | Product Description |
|--------------------|--|
| LQ-M85200-SR4C | QSFP56, 200GBASE-SR4 Transceiver, 70m on OM3 (MMF)and 100m on OM4/OM5 MMF. |